STB5N80K5



N-channel 800 V, 1.50 Ω typ., 4 A MDmesh™ K5 Power MOSFET in a D²PAK package

Datasheet - production data

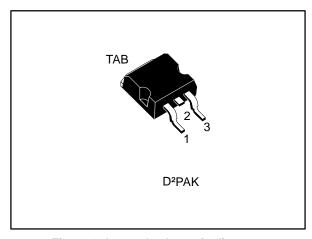
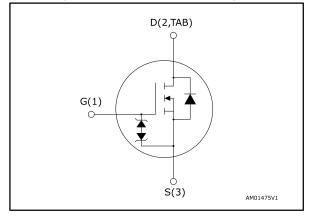


Figure 1: Internal schematic diagram



Features

Order code	V _{DS}	R _{DS(on)} max.	ΙD
STB5N80K5	V 008	1.75 Ω	4 A

- Industry's lowest R_{DS(on)} x area
- Industry's best FoM (figure of merit)
- Ultra-low gate charge
- 100% avalanche tested
- Zener-protected

Applications

• Switching applications

Description

This very high voltage N-channel Power MOSFET is designed using MDmesh™ K5 technology based on an innovative proprietary vertical structure. The result is a dramatic reduction in on-resistance and ultra-low gate charge for applications requiring superior power density and high efficiency.

Table 1: Device summary

Order code	Marking	Package	Packing
STB5N80K5	5N80K5	D²PAK	Tape and reel

Contents STB5N80K5

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STB5N80K5 Electrical ratings

1 Electrical ratings

Table 2: Absolute maximum ratings

Symbol	Parameter	Value	Unit
V _G s	Gate-source voltage	± 30	V
I _D	Drain current (continuous) at T _C = 25 °C	4	Α
I _D	Drain current (continuous) at T _C = 100 °C	2.3	Α
I _D ⁽¹⁾	Drain current (pulsed)	16	Α
P _{TOT}	Total dissipation at T _C = 25 °C	60	W
dv/dt (2)	Peak diode recovery voltage slope	4.5	
dv/dt (3)	MOSFET dv/dt ruggedness	50	V/ns
Tj	Operating junction temperature range	FF to 150	°C
T _{stg}	Storage temperature range	- 55 to 150	C

Notes:

Table 3: Thermal data

Symbol	Parameter	Value	Unit
R _{thj-case}	Thermal resistance junction-case	2.08	°C/W
R _{thj-pcb} ⁽¹⁾	Thermal resistance junction-pcb	35	°C/W

Notes

Table 4: Avalanche characteristics

Symbol	Parameter		Unit
I _{AR}	Avalanche current, repetitive or not repetitive (pulse width limited by Tjmax)	1.2	Α
Eas	Single pulse avalanche energy (starting Tj = 25 °C, $I_D = I_{AR}$, $V_{DD} = 50 \text{ V}$)	165	mJ

⁽¹⁾Pulse width limited by safe operating area

 $^{^{(2)}}I_{SD} \leq 4$ A, di/dt =100 A/ μ s; VDS peak < V(BR)DSS, VDD=640 V

 $^{^{(3)}}V_{DS} \le 640 \text{ V}$

 $^{^{(1)}}$ When mounted on FR-4 board of 1 inch², 2 oz Cu

Electrical characteristics STB5N80K5

2 Electrical characteristics

T_C = 25 °C unless otherwise specified

Table 5: On/off-state

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
V _{(BR)DSS}	Drain-source breakdown voltage	$V_{GS} = 0 \text{ V}, I_D = 1 \text{ mA}$	800			V
		V _{GS} = 0 V, V _{DS} = 800 V			1	μΑ
I _{DSS}	Zero gate voltage drain current	$V_{GS} = 0 \text{ V}, V_{DS} = 800 \text{ V}$ $T_{C} = 125 \text{ °C}^{(1)}$			50	μΑ
I _{GSS}	Gate body leakage current	$V_{DS} = 0 \text{ V}, V_{GS} = \pm 20 \text{ V}$			±10	μΑ
V _{GS(th)}	Gate threshold voltage	$V_{DD} = V_{GS}$, $I_D = 100 \mu A$	3	4	5	V
R _{DS(on)}	Static drain-source on-resistance	$V_{GS} = 10 \text{ V}, I_D = 2 \text{ A}$		1.50	1.75	Ω

Notes:

Table 6: Dynamic

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
Ciss	Input capacitance		1	177	-	pF
Coss	Output capacitance	$V_{DS} = 100 \text{ V}, f = 1 \text{ MHz},$ $V_{GS} = 0 \text{ V}$	1	15	-	pF
Crss	Reverse transfer capacitance		ı	0.3	-	pF
C _{o(tr)} ⁽¹⁾	Equivalent capacitance time related	V 0 V 0 to 640 V	ı	33	-	pF
C _{o(er)} ⁽²⁾	Equivalent capacitance energy related	$V_{GS} = 0$, $V_{DS} = 0$ to 640 V		12		pF
Rg	Intrinsic gate resistance	f = 1 MHz , I _D = 0 A	•	16	-	Ω
Qg	Total gate charge	V _{DD} = 640 V, I _D = 4 A	-	5	-	nC
Q _{gs}	Gate-source charge	V _{GS} = 10 V	1	1.7	-	nC
Q _{gd}	Gate-drain charge	(see Figure 15: "Test circuit for gate charge behavior")	-	2.9	-	nC

Notes:

 $[\]ensuremath{^{(1)}}\mbox{Defined}$ by design, not subject to production test.

 $^{^{(1)}}$ Co(tr) is a constant capacitance value that gives the same charging time as Coss while Vps is rising from 0 to 80% Vpss.

 $^{^{(2)}}$ Co_(er) is a constant capacitance value that gives the same stored energy as Coss while VDs is rising from 0 to 80% VDss.

Table 7: Switching times

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
t _{d(on)}	Turn-on delay time	V_{DD} = 400 V, I_{D} = 2 A, R_{G} = 4.7 Ω	ı	12.7	1	ns
tr	Rise time	V _{GS} = 10 V	-	11.7	-	ns
t _{d(off)}	Turn-off delay time	(see Figure 14: "Test circuit for resistive load switching times"	-	23	-	ns
tf	Fall time	and Figure 19: "Switching time waveform")	-	14.8	-	ns

Table 8: Source-drain diode

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
I _{SD}	Source-drain current		-		4	Α
I _{SDM} ⁽¹⁾	Source-drain current (pulsed)		-		16	Α
V _{SD} ⁽²⁾	Forward on voltage	I _{SD} = 4 A, V _{GS} = 0 V	-		1.5	V
t _{rr}	Reverse recovery time	$I_{SD} = 4 \text{ A}, \text{ di/dt} = 100$	-	265		ns
Qrr	Reverse recovery charge	A/μs,V _{DD} = 60 V (see <i>Figure 16: "Test circuit</i>	-	1.59		μC
I _{RRM}	Reverse recovery current	for inductive load switching and diode recovery times")	-	12		Α
t _{rr}	Reverse recovery time	$I_{SD} = 4 \text{ A}, \text{ di/dt} = 100 \text{ A/}\mu\text{s}$	-	386		ns
Qrr	Reverse recovery charge	$V_{DD} = 60 \text{ V}, T_j = 150 \text{ °C}$ (see Figure 16: "Test circuit	-	2.18		μC
I _{RRM}	Reverse recovery current	for inductive load switching and diode recovery times")	-	11.3		Α

Notes:

Table 9: Gate-source Zener diode

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
$V_{(BR)GSO}$	Gate-source breakdown voltage	$I_{GS}=\pm 1mA$, $I_{D}=0$ A	30	ı	ı	V

The built-in back-to-back Zener diodes are specifically designed to enhance the ESD performance of the device. The Zener voltage facilitates efficient and cost-effective device integrity protection, thus eliminating the need for additional external componentry.

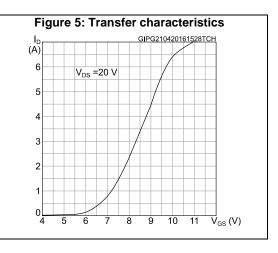


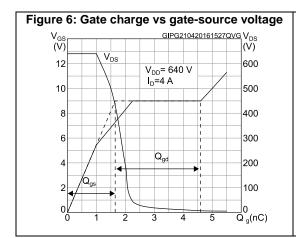
⁽¹⁾Pulse width limited by safe operating area

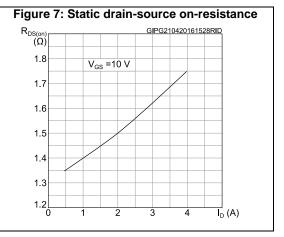
 $^{^{(2)}}$ Pulsed: pulse duration = 300 μ s, duty cycle 1.5%

2.1 Electrical characteristics (curves)

Figure 2: Safe operating area (A) Operation in this area is limited by R_{DS(On)} GIPG280420161139SOA 10 t_o=10 μs t₀=100 µs 10⁰ t_=1 ms t₀=10 ms T_i≤150 °C 10 T_o= 25°C single pulse 10⁻² $\overline{V}_{DS}(V)$ 10¹ 10²







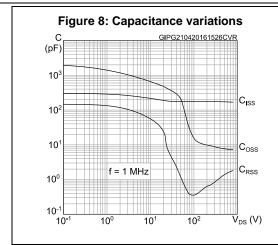


Figure 10: Normalized on-resistance vs temperature

R_{DS(on)} GIPG210420161531RON
(norm.)

2.6 V_{GS} = 10 V

2.2

1.8

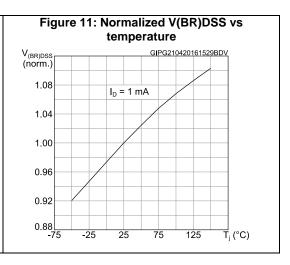
1.4

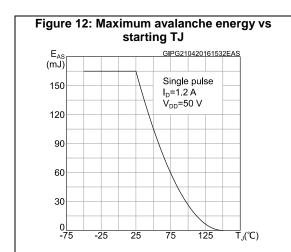
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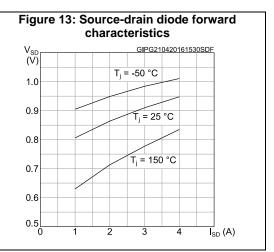
0.6

0.2

-75 -25 25 75 125 T_j (°C)







Test circuits STB5N80K5

3 Test circuits

Figure 14: Test circuit for resistive load switching times

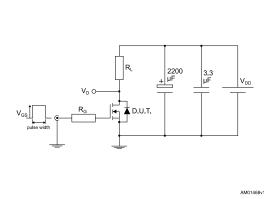


Figure 15: Test circuit for gate charge behavior

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Figure 16: Test circuit for inductive load switching and diode recovery times

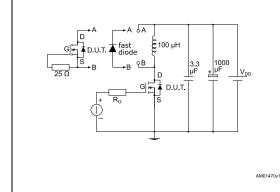


Figure 17: Unclamped inductive load test circuit

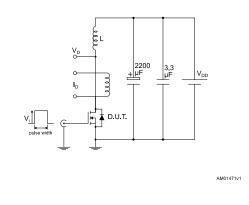


Figure 18: Unclamped inductive waveform

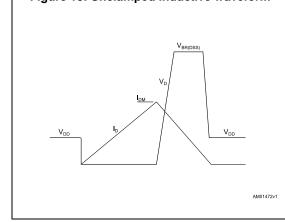
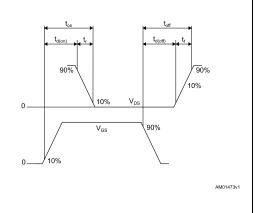


Figure 19: Switching time waveform



STB5N80K5 Package information

4 Package information

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK® packages, depending on their level of environmental compliance. ECOPACK® specifications, grade definitions and product status are available at: **www.st.com**. ECOPACK® is an ST trademark.

4.1 D²PAK (TO-263) type A package information

E1 c2-L1 THERMAL PAD SEATING PLANE COPLANARITY A1 0.25 GAUGE PLANE V2_ 0079457_A_rev22

Figure 20: D²PAK (TO-263) type A package outline

Table 10: D²PAK (TO-263) type A package mechanical data

	10. D 1 Alt (10-203) ty	mm	
Dim.	Min.	Тур.	Max.
А	4.40		4.60
A1	0.03		0.23
b	0.70		0.93
b2	1.14		1.70
С	0.45		0.60
c2	1.23		1.36
D	8.95		9.35
D1	7.50	7.75	8.00
D2	1.10	1.30	1.50
E	10		10.40
E1	8.50	8.70	8.90
E2	6.85	7.05	7.25
е		2.54	
e1	4.88		5.28
Н	15		15.85
J1	2.49		2.69
L	2.29		2.79
L1	1.27		1.40
L2	1.30		1.75
R		0.4	
V2	0°		8°

STB5N80K5 Package information

9.75 16.9 1.6 2.54

Figure 21: D²PAK (TO-263) recommended footprint (dimensions are in mm)

Footprint

4.2 Packing information

Figure 22: Tape outline

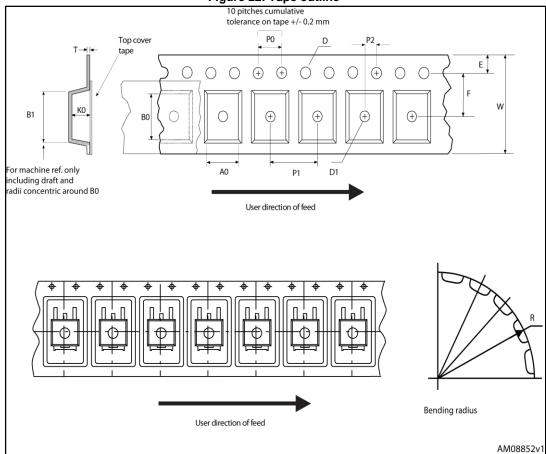


Figure 23: Reel outline

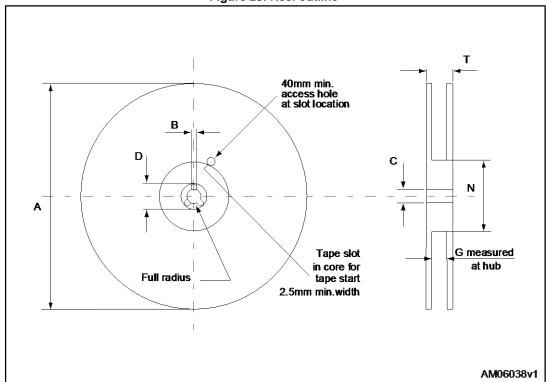


Table 11: D2PAK tape and reel mechanical data

Таре			Reel		
Dim.	mm		Dim	mm	
	Min.	Max.	Dim.	Min.	Max.
A0	10.5	10.7	А		330
В0	15.7	15.9	В	1.5	
D	1.5	1.6	С	12.8	13.2
D1	1.59	1.61	D	20.2	
E	1.65	1.85	G	24.4	26.4
F	11.4	11.6	N	100	
K0	4.8	5.0	Т		30.4
P0	3.9	4.1			
P1	11.9	12.1	Base quantity 1000		1000
P2	1.9	2.1	Bulk quantity 1000		1000
R	50				
Т	0.25	0.35			
W	23.7	24.3			

Revision history STB5N80K5

5 Revision history

Table 12: Document revision history

Date	Revision	Changes
19-Nov-2015	1	First release.
09-May-2016	2	Modified: Table 2: "Absolute maximum ratings", Table 3: "Thermal data", Table 5: "On/off-state", Table 6: "Dynamic", Table 7: "Switching times" and Table 8: "Source-drain diode" Updated: Section 4: "Test circuits" Added: Section 3.1: "Electrical characteristics (curves)" Minor text changes.

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